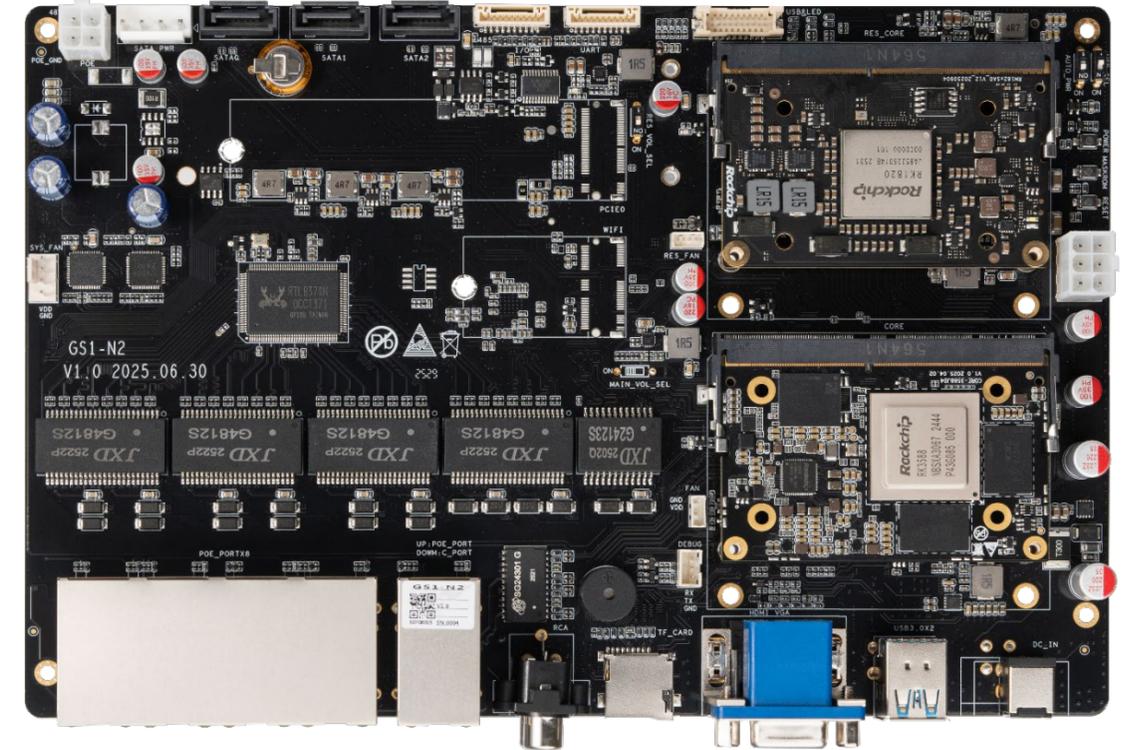




RK182X Development Kit

V1.0 2025-11-27

T-CHIP INTELLIGENCE TECHNOLOGY



Product features



Dual-core heterogeneous design

Adopting the dual-core heterogeneous architecture of RK3588 and RK182X, interconnected at high speed via the PCIe interface to achieve efficient collaboration: RK3588 coordinates task scheduling and data preprocessing, while RK182X focuses on core AI inference computing power output, supporting model parallelism and multi-task collaboration capabilities.



3D RAM stacked architecture, edge AI acceleration

Adopting a 3D RAM stacked architecture, the RK182X breaks through data transmission bottlenecks via ultra-high DRAM bandwidth. It enables smooth operation of large models with 3B/7B parameters, significantly optimizing response latency for large model scenarios such as LLMs (Large Language Models) and VLMs (Vision-Language Models).



8K codec and multi-channel 4K video stream parallel processing

The RK3588 not only supports 8K video decoding and encoding but also enables image scaling and cropping via hardware acceleration, easily handling parallel processing of multi-channel 4K video streams. Combined with the AI computing power collaboration of the RK182X coprocessor, it can efficiently complete real-time AI analysis of video streams.



Integrated high-bandwidth on-chip DRAM

Equipped with integrated high-bandwidth embedded on-chip DRAM (2.5GB/5GB versions), it delivers an edge-side generation rate exceeding 100 tokens/s and an end-to-end latency as low as 0.1s, providing efficient support for local intelligent computing.

Product features



Edge computing with low latency, millisecond-level response

Local AI processing reduces network dependency, enabling millisecond-level response and data privacy protection. Combined with the scheduling capability of the RK3588, the RK182X's dedicated NPU maintains real-time decision-making in weak network environments, enhancing overall system reliability and security.



Multiple gigabit PoE ports for multi-device interconnection

Equipped with 10 Gigabit Ethernet ports, 9 of which support Power over Ethernet (PSE) functionality, high-throughput data transmission, and multi-device interconnection. Boasting strong compatibility, it works with network cameras from numerous mainstream manufacturers compliant with ONVIF and RTSP standards.



Onboard SATA/PCIe interfaces for ultra-large storage expansion

Equipped with an onboard SATA3.0, it supports expansion of 3.5-inch/2.5-inch SSDs/HDDs. The M.2 PCIe interface enables expansion of PCIe NVMe SSDs, allowing storage capacity to scale up to terabyte-level. Combined with the high-performance RK182X coprocessor, it can efficiently process AI datasets or video logs, eliminating cloud transmission risks.



Rich expansion interfaces

Offering diverse interfaces including USB3.0, HDMI, VGA, RS485, IO, and UART, it facilitates hardware expansion and integration of sensors or modules, enabling multi-modal input to further enhance product adaptability and scalability.

Specifications



Specifications		
Basic Specifications	Main mod	RK3588 module(Core-3588JD4): LPDDR4/LPDDR4x (4/8/16/32GB) + eMMC (32/64/128/256GB), 6T (INT8) computing power
	Sub mod	Optional RK1820/RK1828 module RK1820 module: 2.5GB on-chip DRAM, 20TOPS (INT8) computing power, which can smoothly run large models within 3B RK1828 module: 5GB on-chip DRAM, 20TOPS (INT8) computing power, which can smoothly run large models within 7B
	Video encoding	Main mod: 8K@30fps H.265/H.264
	Video decoding	Main mod: 8K@60fps H.265/VP9/AVS2, 8K@30fps H.264 AVC/MVC, 4K@60fps AV1, 1080P@60fps MPEG-2/-1/VC-1/VP8
	Storage expansion	1 × TF Card
	Power	Mainboard power supply (dual options): 1) DC 24V/5A (5.5 × 2.1mm) 2) 12V ATX connector power supply 48V ATX connector: -- After connecting an external 48V power supply to the ATX connector, it can provide PoE power (PSE) to terminal devices. * For 12V ATX and 48V ATX connectors, power supply can adopt: 280W AC Power Supply (Input: 100V AC ~ 240V AC, 50Hz~60Hz, 6A; Output 1: 12V DC, 5A; Output 2: 52V DC, 4.6A; Hot-swap not supported)
	OS	Linux
	Size	231.27mm × 164.13mm × 33.57mm
	Weight	≈350g
	Environment	Operating Temperature: -20°C ~ 60°C, Storage Temperature: -20°C ~ 70°C, Storage Humidity: 10% ~ 90%RH (non-condensing)
Interface Specifications	Network	8 × Gigabit Ethernet (RJ45): Supports PSE functionality. After connecting an external 48V ATX power supply, it can provide PoE power to terminal devices 2 × LAN (RJ45, 1000Mbps): Upper LAN ports support PSE functionality. After connecting an external 48V ATX power supply, it can provide PoE power to terminal devices Supports 2.4GHz/5GHz dual-band WiFi (expanded via M.2 E-KEY, shared with SATA0; M.2 E-KEY not populated by default)
	Video output	1 × VGA (Maximum resolution 1080P), 1 × HDMI2.0 (Default support for 1080P)
	Audio	1 × Audio input, 1 × Audio output
	SATA/PCIe	① 1 × SATA3.0 (SATA2) ② Three optional functions (select one): 1 × SATA3.0 (SATA0, shared with PCIe; default function) 1 × M.2 (shared with SATA0, M-KEY; supports PCIe NVMe 2280 SSD expansion; not populated by default) 1 × M.2 (shared with SATA0, E-KEY; supports dual-band WiFi expansion; not populated by default)
	USB	2 × USB3.0, 1 × USB3.0 (20Pin-1.25mm wafer)
	Button	1 × Power, 1 × MaskRom, 1 × Reset
	DIP switch	1 × Automatic power-on DIP switch (ON: Automatically turn on after powering; Off: Press the power button to manually power on after powering on) 1 × USB mode toggle switch (ON: USB HOST; Off: USB Device)
Other interfaces	1 × RS485&IO (10Pin-1.25mm), 1 × SATA_PWR (4Pin-3.96mm), 1 × UART (10Pin-1.25mm), 2 × FAN (4Pin-1.25mm), 1 × SYS_FAN (4Pin-2.54mm), 1 × Debug (3Pin-2mm), 1 × 12V ATX connector (6Pin-4.2mm), 1 × 48V ATX connector (4Pin-4.2mm)	



Local deployment of large models

The RK182X features an NPU architecture specifically designed for AI. Via its high-speed PCIe interface, it works collaboratively with the main SOC. Equipped with built-in high-bandwidth DRAM, it facilitates the local deployment and efficient operation of large models.

RK182X LLM Running Performance

Platform	Model Name	TTFT (ms)	TPS (tokens/s)
RK182X	Qwen2.5-0.5B	23.50	180.77
RK182X	Qwen2.5-3B	84.30	87.65
RK1828	Qwen2.5-7B	161	59.09
RK1828	Qwen3-4B	111.44	64.96

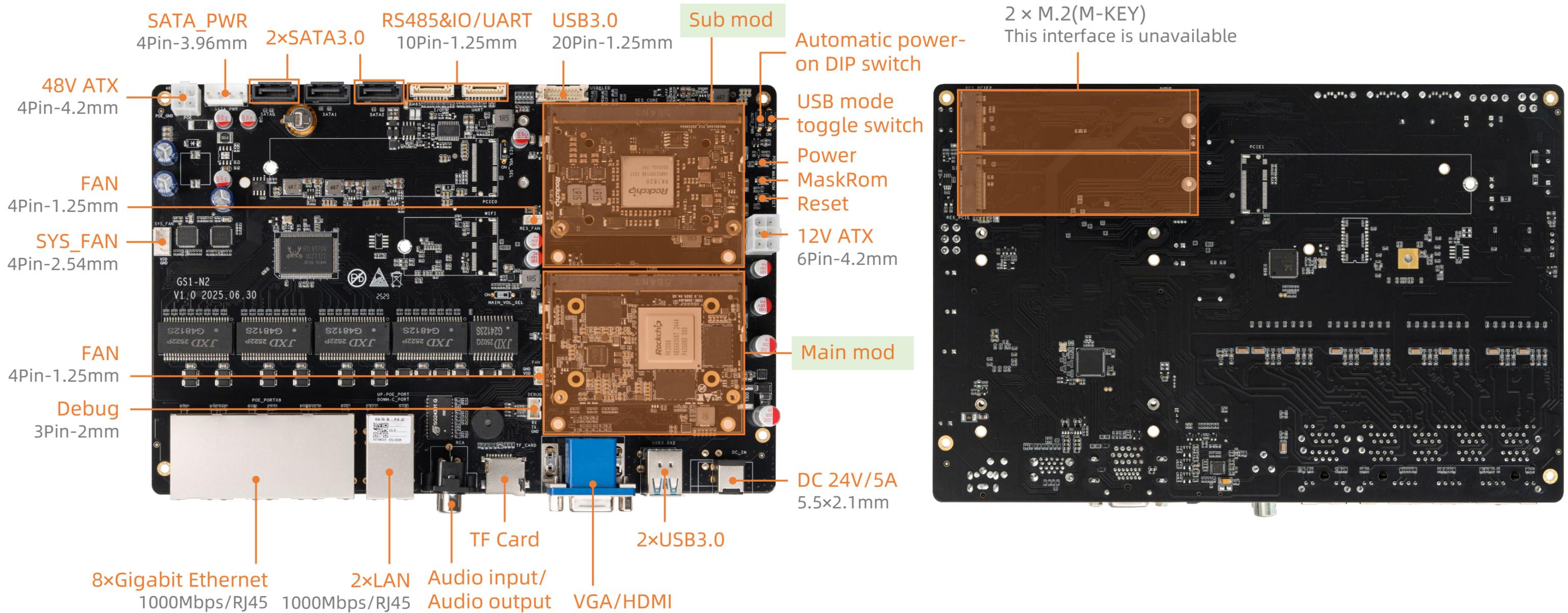
* Data based on RKNN3 SDK; all models use w4a16 quantization, with LLM input set to 128.

RK182X VLM Running Performance

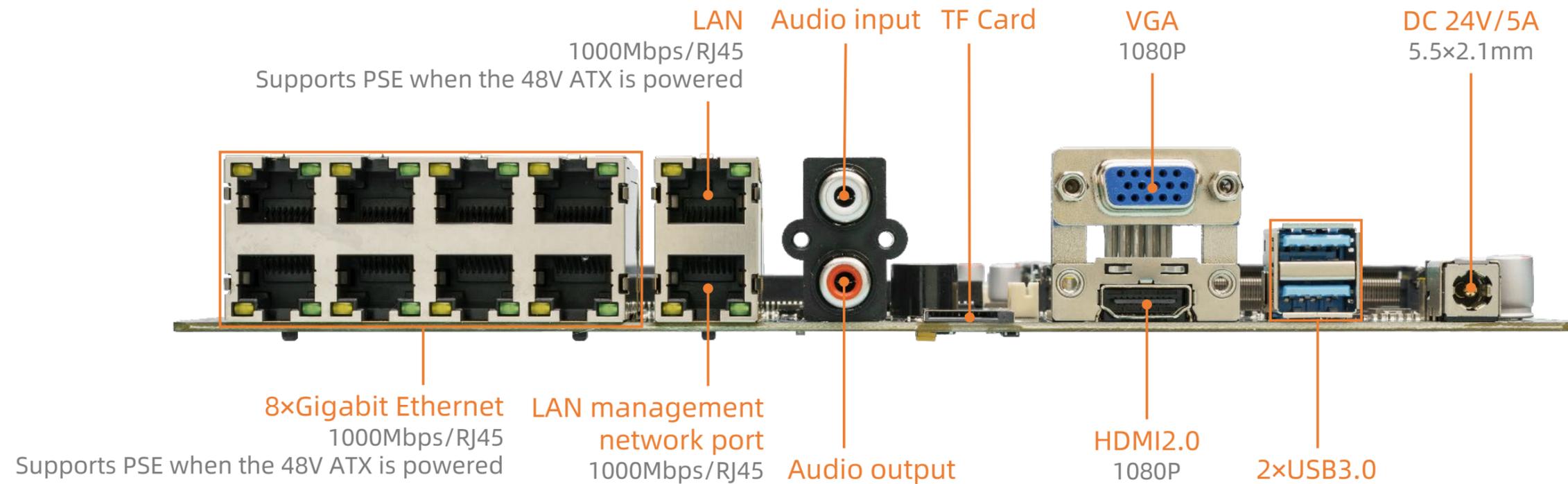
Platform	Model Name	TTFT (ms)	TPS (tokens/s)
RK182X	fastvlm-1.5B-stage3	49.21	124.72
RK182X	InternVL3-2B	48.76	127.01
RK1820	Qwen2.5-VL-3B	114.96	46.45
RK1828	Qwen2.5-VL-3B	87.08	85.98
RK1828	Qwen2.5-VL-7B	161.12	58.94
RK1828	InternVL3.5-4B	109.54	64.20

* Data based on RKNN3 SDK; all models use w4a16 quantization, with the LLM component of VL having an input of 128.

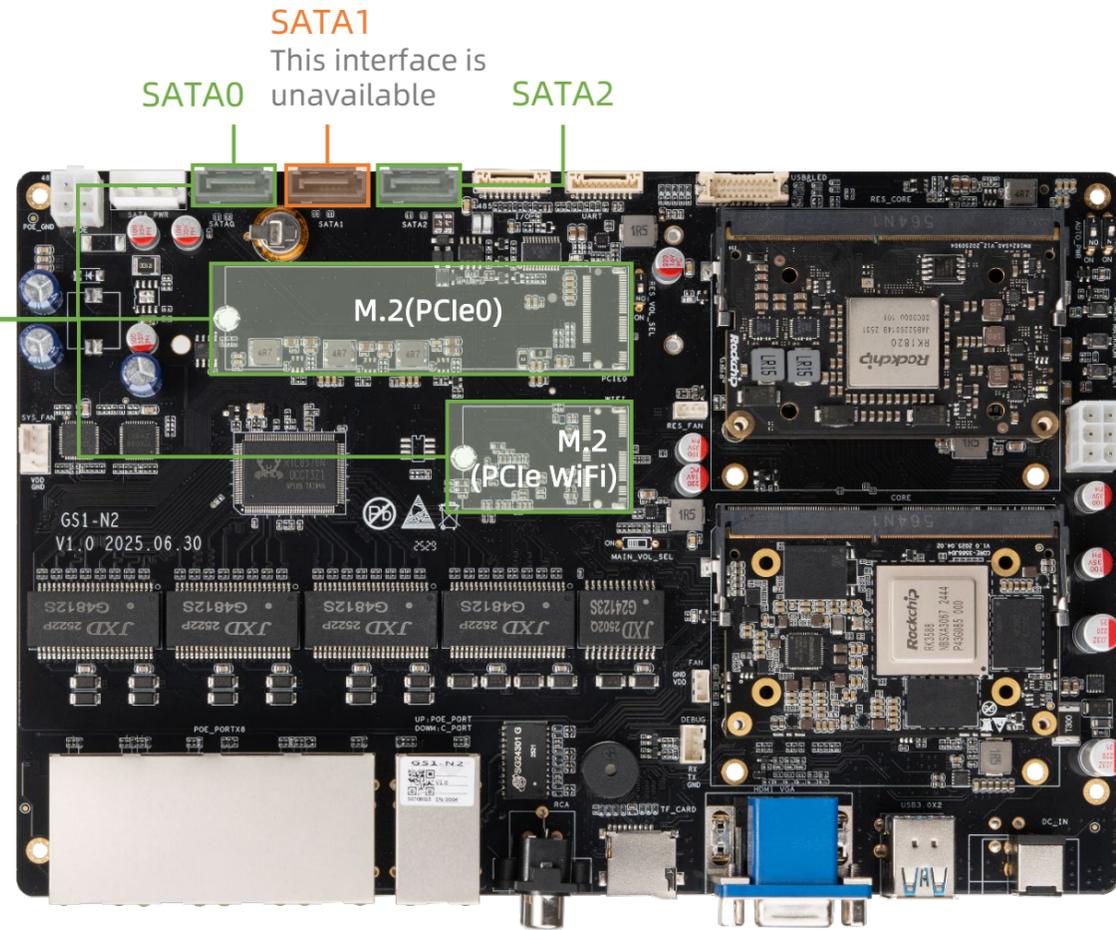
Interface description



Interface description



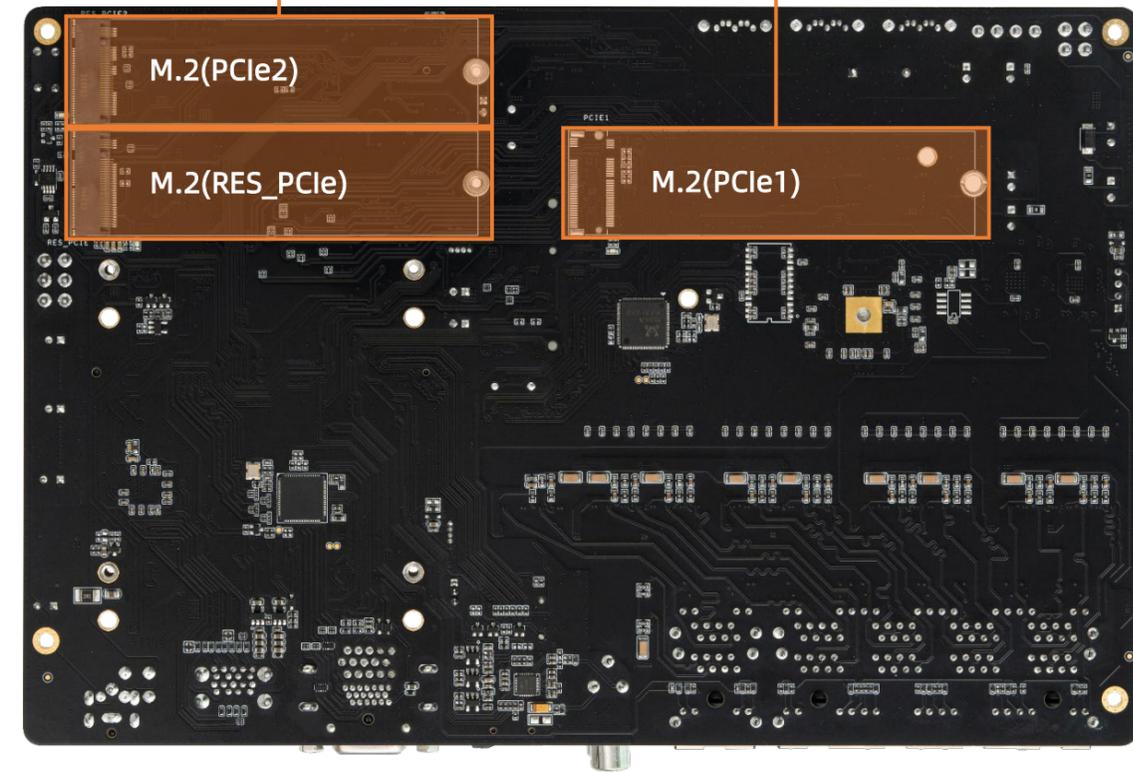
Interface description



Choose one of three interface functions, and when using one of the interfaces, the other two interfaces are not available
PCIe0 and PCIe WiFi not populated by default

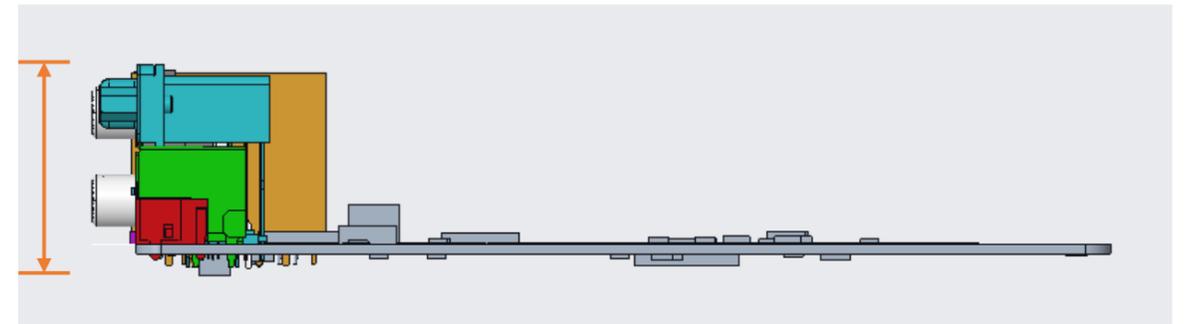
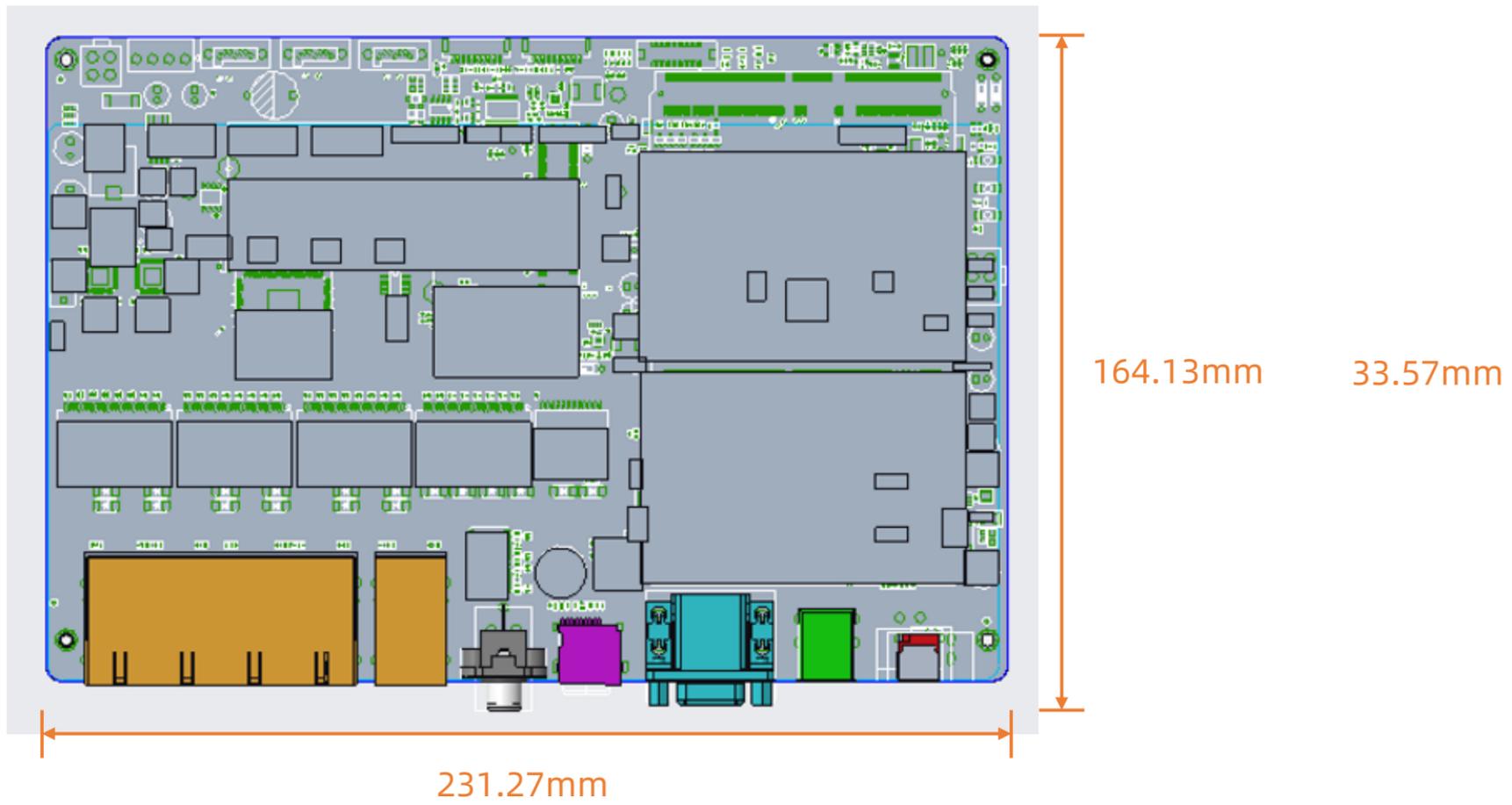
SATA1
This interface is unavailable

3 x M.2(M-KEY)
This interface is unavailable



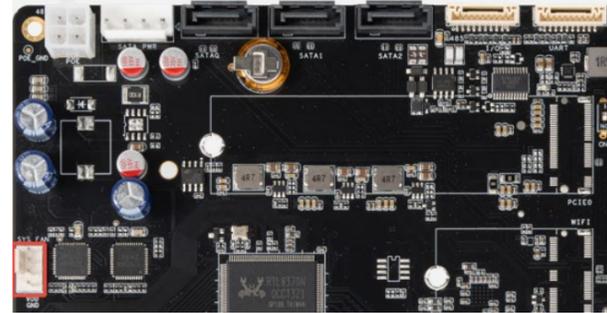
Main mod	Sub mod	Availability
RK3588 module (Core-3588JD4)	RK1820 module	1) SATA0, PCIe0, PCIe WiFi(M.2) : Choose one of three 2) SATA2 is available 3) Other PCIe/SATA are not available
	RK1828 module	

Dimension



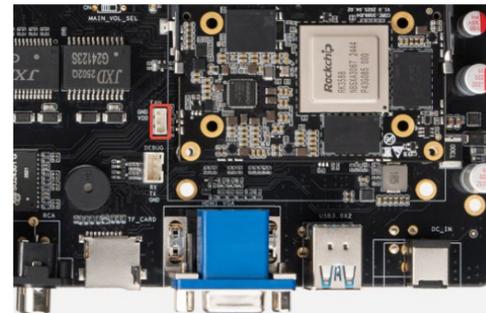
Interface definition

1.(J23) FAN: 4PIN 2.54mm pitch



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	FAN TACH Input	3.3
2	VSYS_12V (12V Output)	12	4	FAN_PWM Output	3.3

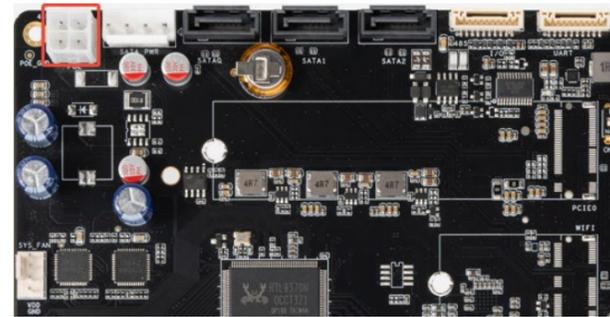
2.(J6) FAN: 4PIN 1.25mm pitch wafer socket



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	FG Input	3.3
2	FAN+(5V Output)	5	4	FAN_PWM Output	5

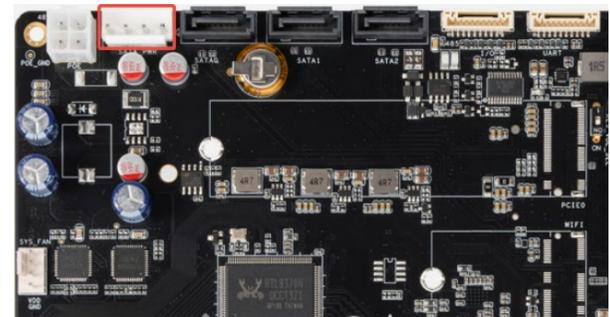
Interface definition

3.(J15) POE Power Input: 4PIN 4.2mm pitch (WHITE)



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	POE_48V(48V~53V Input)	48~53
2	GND		4	POE_48V(48V~53V Input)	48~53

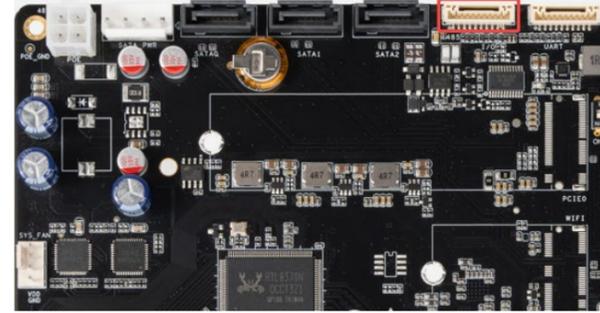
4.(J7) SATA_POWER Output: 4PIN 3.96mm pitch (WHITE)



NO.	Definition	Power/V	NO.	Definition	Power/V
1	VSYS_12V(12V Output)	12	3	GND	
2	GND		4	VCC5V0_SYS(5V Output)	5

Interface definition

5.(J21) I/O PORT: 10PIN 1.25mm pitch



NO.	Definition	Power/V	NO.	Definition	Power/V
1	VSYS_12V(12V Output)	12	6	IO4	1.8
2	RS485_B	3.3	7	IO3	1.8
3	RS485_A	3.3	8	IO2	1.8
4	GND		9	IO1	1.8
5	IO5	1.8	10	VCC5V0_SYS(5V Output)	5

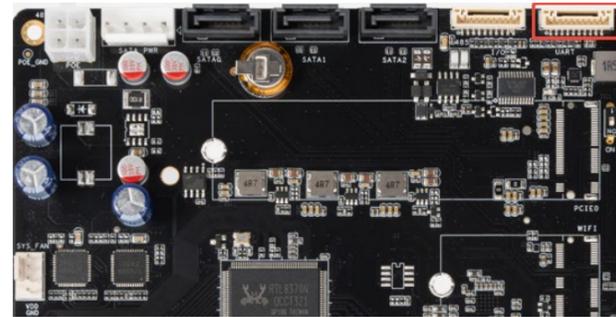
6.(J19) DEBUG_UART: 3PIN 2.0mm pitch wafer socket



NO.	Definition	Power/V	NO.	Definition	Power/V
1	UART0_RXD	3.3	3	GND	
2	UART0_TXD	3.3			

Interface definition

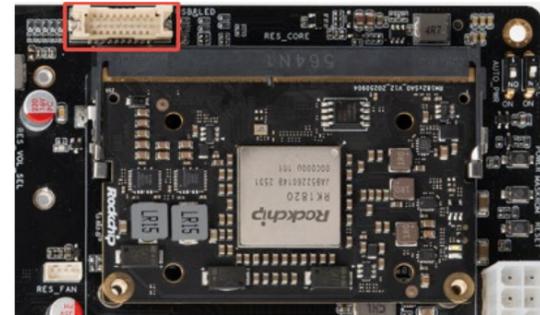
7.(J16) UART PORT: 10PIN 1.25mm pitch



NO.	Definition	Power/V	NO.	Definition	Power/V
1	UART4_TX	1.8	6	UART0_RXD	3.3
2	UART4_RX	1.8	7	VCC5V0_SYS(5V Output)	5
3	UART7_TX	1.8	8	VCC5V0_SYS(5V Output)	5
4	UART7_RX	1.8	9	GND	
5	UART0_TXD	3.3	10	GND	

Interface definition

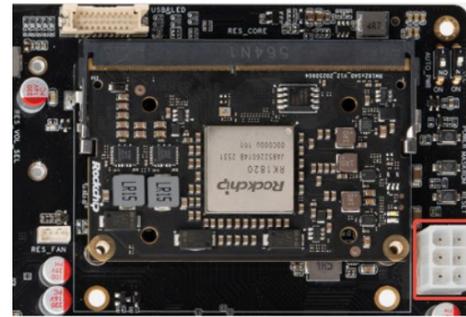
8.(J13) USB&LED: 20PIN(10*2) 1.25mm pitch



NO.	Definition	Power/V	NO.	Definition	Power/V
1	VCC5V0_USB_HOST2	5	2	HUB_USB1_SSTX_N	-
3	VCC5V0_USB_HOST2	5	4	HUB_USB1_SSTX_P	-
5	USB20_DM	-	6	GND	
7	USB20_DP	-	8	HUB30_USB1_SSRX_N	-
9	PWR_LED	1.8	10	HUB30_USB1_SSRX_P	-
11	SATA_LED	1.8	12	GND	
13	NET_LED	1.8	14	POWER_KEY_IN (POWER_KEY Input)	5
15	WARN_LED	1.8	16	POWER_KEY_OUT(POWER_KEY Output)	5
17	RES_LED	1.8	18	VCC5V0_SYS (5.0V Output)	5
19	GND		20	GND	

Interface definition

9.(J11) 12V_IN: 6PIN 4.2mm pitch (WHITE)



NO.	Definition	Power/V	NO.	Definition	Power/V
1	DC_IN(12V Input)	12	4	GND	
2	DC_IN(12V Input)	12	5	GND	
3	DC_IN(12V Input)	12	6	GND	

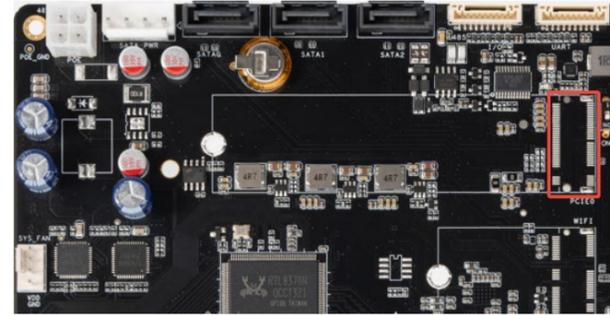
10.(J24) RES_FAN: 4PIN 1.25mm pitch wafer socket



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		3	RES_FAN_TACH Input	5
2	RES_FAN+	5	4	RES_PWM Output	5

Interface definition

11.(U16) PCIE M.2 NGFF M-KEY SOCKET (Default:NC)



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		2	VCC3V3_PCIE1 (3.3V Output)	3.3
3	GND		4	VCC3V3_PCIE1 (3.3V Output)	3.3
5	NC		6	NC	
7	NC		8	NC	
9	GND		10	DAS/DSS [pull up resistor10K]	3.3
11	NC		12	VCC3V3_PCIE1 (3.3V Output)	3.3
13	NC		14	VCC3V3_PCIE1 (3.3V Output)	3.3
15	NC		16	VCC3V3_PCIE1 (3.3V Output)	3.3
17	NC		18	VCC3V3_PCIE1 (3.3V Output)	3.3
19	NC		20	NC	
21	GND		22	NC	
23	NC		24	NC	
25	NC		26	NC	
27	GND		28	NC	



Interface definition

29	NC		30	NC	
31	NC		32	NC	
33	GND		34	NC	
35	NC		36	NC	
37	NC		38	DEVSLP1	3.3
39	GND		40	NC	
41	PCIE0_RX0_P / SATA_RX0_P	-	42	NC	
43	PCIE0_RX0_N / SATA_RX0_N	-	44	NC	
45	GND		46	NC	
47	PCIE0_TX0_N / SATA_TX0_N	-	48	NC	
49	PCIE0_TX0_P / SATA_TX0_P	-	50	PCIE0_RST*	3.3
51	GND		52	PCIE0_CLKREQ*	3.3
53	PCIE0_EP_CLK_N	-	54	PCIE_WAKE*	3.3
55	PCIE0_EP_CLK_P	-	56	NC	
57	GND		58	NC	
67	NC		68	NC	
69	GND		70	VCC3V3_PCIE1 (3.3V Output)	3.3
71	GND		72	VCC3V3_PCIE1 (3.3V Output)	3.3
73	GND		74	VCC3V3_PCIE1 (3.3V Output)	3.3
75	GND				

Interface definition

12.(U52) PCIE-WIFI M.2 Module E-KEY (Default:NC)



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		2	WIFI_3V3 (3.3V Output)	3.3
3	NC		4	WIFI_3V3 (3.3V Output)	3.3
5	NC		6	NC	
7	NC		8	NC	
9	NC		10	NC	
11	NC		12	NC	
13	NC		14	NC	
15	NC		16	NC	
17	NC		18	GND	
19	NC		20	NC	
21	NC		22	NC	
23	NC		32	NC	
33	GND		34	NC	
35	PCIE0_TX0_P / SATA_TX0_P (Series capacitor 220nF)	-	36	NC	

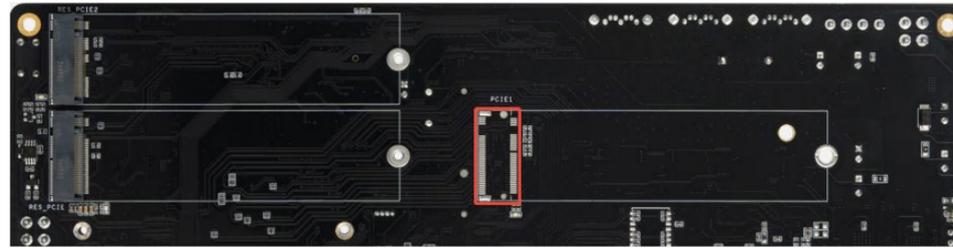


Interface definition

37	PCIE0_TX0_N / SATA_TX0_N (Series capacitor 220nF)	-	38	NC	
39	GND		40	NC	
41	PCIE0_RX0_P / SATA_RX0_P	-	42	NC	
43	PCIE0_RX0_N / SATA_RX0_N	-	44	NC	
45	GND		46	NC	
47	PCIE0_EP_CLK_P	-	48	NC	
49	PCIE0_EP_CLK_N	-	50	32KOUT_WIFI	1.8
51	GND		52	PCIE0_RST*	3.3
53	PCIE0_CLKREQ*	3.3	54	NC	
55	PCIE_WAKE*	3.3	56	WIFI_DISABLE_L	3.3
57	GND		58	NC	
59	NC		60	NC	
61	NC		62	NC	
63	GND		64	NC	
65	NC		66	NC	
67	NC		68	NC	
69	GND		70	NC	
71	NC		72	WIFI_3V3 (3.3V Output)	3.3
73	NC		74	WIFI_3V3 (3.3V Output)	3.3
75	GND				

Interface definition

13.(U4) PCIE M.2 NGFF M-KEY SOCKET (Default:NC)



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		2	VCC3V3_PCIE0 (3.3V Output)	3.3
3	GND		4	VCC3V3_PCIE0 (3.3V Output)	3.3
5	PCIE1_RX3_N	-	6	NC	
7	PCIE1_RX3_P	-	8	NC	
9	GND		10	DAS/DSS [pull up resistor10K]	3.3
11	PCIE1_TX3_N	-	12	VCC3V3_PCIE0 (3.3V Output)	3.3
13	PCIE1_TX3_P	-	14	VCC3V3_PCIE0 (3.3V Output)	3.3
15	GND		16	VCC3V3_PCIE0 (3.3V Output)	3.3
17	PCIE1_RX2_N	-	18	VCC3V3_PCIE0 (3.3V Output)	3.3
19	PCIE1_RX2_P	-	20	NC	
21	GND		22	NC	
23	PCIE1_TX2_N	-	24	NC	
25	PCIE1_TX2_P	-	26	NC	
27	GND		28	NC	
29	PCIE1_RX1_N	-	30	NC	

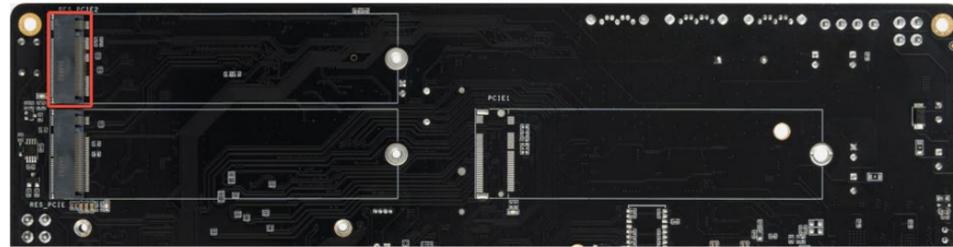


Interface definition

31	PCIE1_RX1_P	-	32	NC	
33	GND		34	NC	
35	PCIE1_TX1_N	-	36	NC	
37	PCIE1_TX1_P	-	38	DEVSLP1 [pull up resistor10K]	3.3
39	GND		40	NC	
41	PCIE1_RX0_N	-	42	NC	
43	PCIE1_RX0_P	-	44	NC	
45	GND		46	NC	
47	PCIE1_TX0_N	-	48	NC	
49	PCIE1_TX0_P	-	50	PCIE1_RST*	3.3
51	GND		52	PCIE1_CLKREQ*	3.3
53	PCIE30_PORT0_CLKN	-	54	PCIE_WAKE*	3.3
55	PCIE30_PORT0_CLKP	-	56	NC	
57	GND		58	NC	
67	NC		68	NC	
69	GND		70	VCC3V3_PCIE0 (3.3V Output)	3.3
71	GND		72	VCC3V3_PCIE0 (3.3V Output)	3.3
73	GND		74	VCC3V3_PCIE0 (3.3V Output)	3.3
75	GND				

Interface definition

14.(U60) PCIE M.2 NGFF M-KEY SOCKET



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		2	VCC3V3_PCIE2 (3.3V Output)	3.3
3	GND		4	VCC3V3_PCIE2 (3.3V Output)	3.3
5	NC		6	NC	
7	NC		8	NC	
9	GND		10	DAS/DSS [pull up resistor10K]	3.3
11	NC		12	VCC3V3_PCIE2 (3.3V Output)	3.3
13	NC		14	VCC3V3_PCIE2 (3.3V Output)	3.3
15	GND		16	VCC3V3_PCIE2 (3.3V Output)	3.3
17	NC		18	VCC3V3_PCIE2 (3.3V Output)	3.3
19	NC		20	NC	
21	GND		22	NC	
23	NC		24	NC	
25	NC		26	NC	
27	GND		28	NC	
29	PCIE2_RX1_N	-	30	NC	

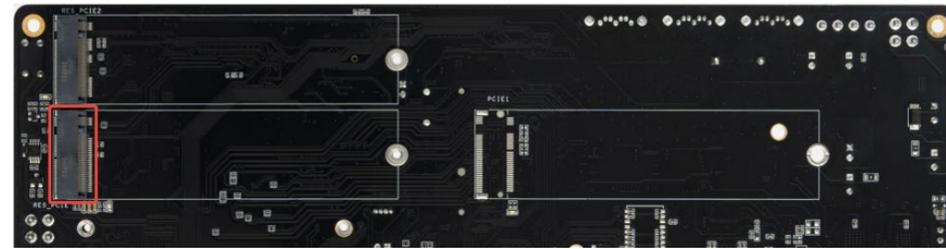


Interface definition

31	PCIE2_RX1_P	-	32	NC	
33	GND		34	NC	
35	PCIE2_TX1_N (Series capacitor 220nF)	-	36	NC	
37	PCIE2_TX1_P (Series capacitor 220nF)	-	38	NC	
39	GND		40	NC	
41	PCIE2_RX0_N	-	42	NC	
43	PCIE2_RX0_P	-	44	NC	
45	GND		46	NC	
47	PCIE2_TX0_N (Series capacitor 220nF)	-	48	NC	
49	PCIE2_TX0_P (Series capacitor 220nF)	-	50	PCIE2_RST*	3.3
51	GND		52	PCIE2_CLKREQ*	3.3
53	PCIE2_CLK_N	-	54	PCIE_WAKE*	3.3
55	PCIE2_CLK_P	-	56	NC	
57	GND		58	NC	
67	NC		68	NC	
69	GND		70	VCC3V3_PCIE2 (3.3V Output)	3.3
71	GND		72	VCC3V3_PCIE2 (3.3V Output)	3.3
73	GND		74	VCC3V3_PCIE2 (3.3V Output)	3.3
75	GND				

Interface definition

15.(U24) PCIE M.2 NGFF M-KEY SOCKET



NO.	Definition	Power/V	NO.	Definition	Power/V
1	GND		2	VCC3V3_PCIE0_RES(3.3V Output)	3.3
3	GND		4	VCC3V3_PCIE0_RES(3.3V Output)	3.3
5	NC		6	NC	
7	NC		8	NC	
9	GND		10	DAS/DSS [pull up resistor10K]	3.3
11	NC		12	VCC3V3_PCIE0_RES(3.3V Output)	3.3
13	NC		14	VCC3V3_PCIE0_RES(3.3V Output)	3.3
15	GND		16	VCC3V3_PCIE0_RES(3.3V Output)	3.3
17	NC		18	VCC3V3_PCIE0_RES(3.3V Output)	3.3
19	NC		20	NC	
21	GND		22	NC	
23	NC		24	NC	
25	NC		26	NC	
27	GND		28	NC	
29	NC		30	NC	

Interface definition



31	NC		32	NC	
33	GND		34	NC	
35	NC		36	NC	
37	NC		38	RES_DEVSLP [pull up resistor10K]	3.3
39	GND		40	NC	
41	PCIE2_RX0_N	-	42	NC	
43	PCIE2_RX0_P	-	44	NC	
45	GND		46	NC	
47	RES_PCIE1_TX0_N (Series capacitor 100nF)	-	48	NC	
49	RES_PCIE1_TX0_P (Series capacitor 100nF)	-	50	RES_PCIE1_RST*	3.3
51	GND		52	RES_PCIE1_CLKREQ*	3.3
53	RES_PCIE1_EP_CLK_N	-	54	PCIE_WAKE*	3.3
55	RES_PCIE1_EP_CLK_P	-	56	NC	
57	GND		58	NC	
67	NC		68	NC	
69	GND		70	VCC3V3_PCIE0_RES (3.3V Output)	3.3
71	GND		72	VCC3V3_PCIE0_RES (3.3V Output)	3.3
73	GND		74	VCC3V3_PCIE0_RES (3.3V Output)	3.3
75	GND				



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